| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|---|---|---|---|---|---|---|
| L1 | 386 | cod$4 same (microparticl$4 or micro-particl$4 or (micro adj particle$4)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 09:41 |
| L2 | 8 | cod$4 same (microparticl$4 or micro-particl$4 or (micro adj particle$4)) same hole$1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 09:18 |
| L5 | 579 | (micron$1 or micrometer$1) adj (chip$4 or tag$1 or label$1 or wafer$1) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 09:37 |
| L7 | 7 | 5 and "235"/$.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 09:33 |
| L8 | 10 | 5 and "435"/$.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 11:49 |
| L10 | 265 | (micron$1 or micrometer$1) adj (chip$4 or tag$1 or label$1 or wafer$1) same (size or thick$5) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 09:41 |
| L13 | 3 | cod$4 and (microparticl$4 or micro-particl$4 or (micro adj particle$4)) and (micron$1 or micrometer$1) adj (chip$4 or tag$1 or label$1 or wafer$1) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 09:44 |
| L23 | 80 | (micrometer adj10 micrometer) same wafer same thickness | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 10:51 |
| L28 | 58 | ((micrometer adj10 micrometer) same wafer same thickness) and ((etch$4) same wafer) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 10:45 |

| L29 | 3 | ((micrometer adj10 micrometer) same wafer same thickness) and ((etch$4) same wafer same (data or information or marking)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 10:46 |
|-----|-----|-----|-----|-----|-----|-----|
| L35 | 11 | (micrometer adj10 micrometer) same wafer same holes | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 10:52 |
| L45 | 1 | (micrometer adj10 micrometer) same (punch$4) same code | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 10:57 |
| L46 | 5 | (micrometer adj10 micrometer) and (punch$4 same code) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 10:59 |
| L47 | 175 | (micrometer near10 thickness) and ((punch$1 or holes) same (data or information or code or marking$1)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 11:06 |
| L48 | 1 | l47 and "235"/$.ccls.. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 11:00 |
| L49 | 68 | ((micrometer near10 thickness) same substrate) and ((punch$1 or holes) same (data or information or code or marking$1)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 11:07 |
| L50 | 134 | 5 and "438"/$.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/10/03 11:49 |